

150A 1200V Half bridge module

1 Description

These Insulated Gate Bipolar Transistor used advanced trench and Fieldstop technology design, provided excellent $V_{CE(sat)}$ and switching speed ,low gate charge. Which accords with the RoHS standard.

2 Features

- FS Trench Technology, Positive temperature coefficient
- Low saturation voltage: $V_{CE(sat)}$, typ = 2.55V @ $I_C = 150A$ and $T_j = 25^\circ C$
- Extremely enhanced avalanche capability

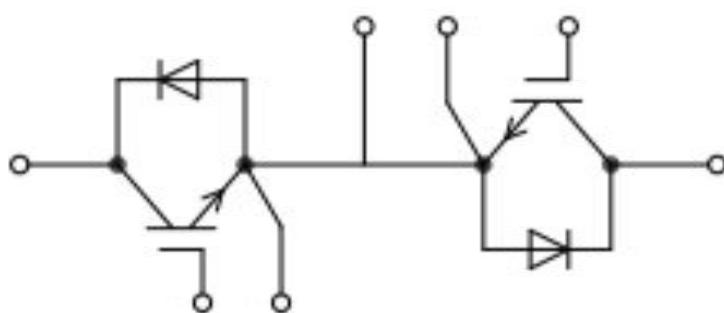


3 Applications

- Welding
- UPS
- Three-leve Inverter
- AC and DC servo drive amplifier

Type	V_{CE}	I_C	$V_{CE(sat)}, T_j=25^\circ C$	T_{jop}	Package
DGA150H120M2T	1200V	150A ($T_j=100^\circ C$)	2.55V (Typ)	150°C	34MM

4 Equivalent Circuit Schematic



5 Electrical Characteristics

5.1 Absolute Maximum Ratings (IGBT) (Tc=25°C,unless otherwise specified)

Parameter		Symbol	Value	Units
Collector-to-Emitter Voltage		V _{CE}	1200	V
Gate-to-Emitter Voltage		V _{GE}	±20	V
DC Collector current	T _j =100°C	I _C	150	A
Pulsed Collector Current #1		I _{CM}	1200	A
T _{vj} = 150°C , V _{CC} = 600V, V _{GE} = 15V , Short circuit withstand time,		T _{SC}	6	us

Notes: #1 Pulse duration is limited by T_{j,max}

5.2 Absolute Maximum Ratings (Diode) (Tc=25°C,unless otherwise specified)

PARAMETER		SYMBOL	VALUE	UNIT
Peak Repetitive Reverse Voltage		V _{RRM}	1200	V
DC Blocking Voltage		V _R	1200	V
Average Rectified Forward Current		I _{F(AV)}	150	A
Repetitive Peak Surge Current	tp=1ms	I _{FRM}	300	A
Nonrepetitive Peak Surge Current	tp=10ms	I _{FSM}	750	A

5.3 IGBT Module

Parameter		Symbol	VALUE	Units
Junction Temperature Range		T _{jmax}	-40~175	°C
Operating Junction Temperature		T _{jop}	-40~150	°C
Storage Temperature Range		T _{stg}	-40~120	°C
Isolation Voltage R _{MS} ,f=50Hz,t=1min		V _{ISO}	3500	V

5.4 Thermal Characteristics (IGBT Module)

Parameter		Symbol	Rating	Units
Thermal Resistance Junction to Case	IGBT	R _{thJC}	0.18	°C/W
	Diode		0.45	

5.5 Module characteristics

Parameter	Symbol	Conditions	VALUE	Units
Material of module baseplate			Cu+Ni	
Internal isolation		Basic insulation	Improved Al ₂ O ₃ ceramic	
Mounting torque of screws to heat sink	M _s	M5	3.0-6.0	N·m
Mounting torque of screws to terminals	M _t	M6	2.5-5.0	N·m
Comperative tracking index	C _{TI}		>175	
Stray inductance module	L _{SCE}		19	nH

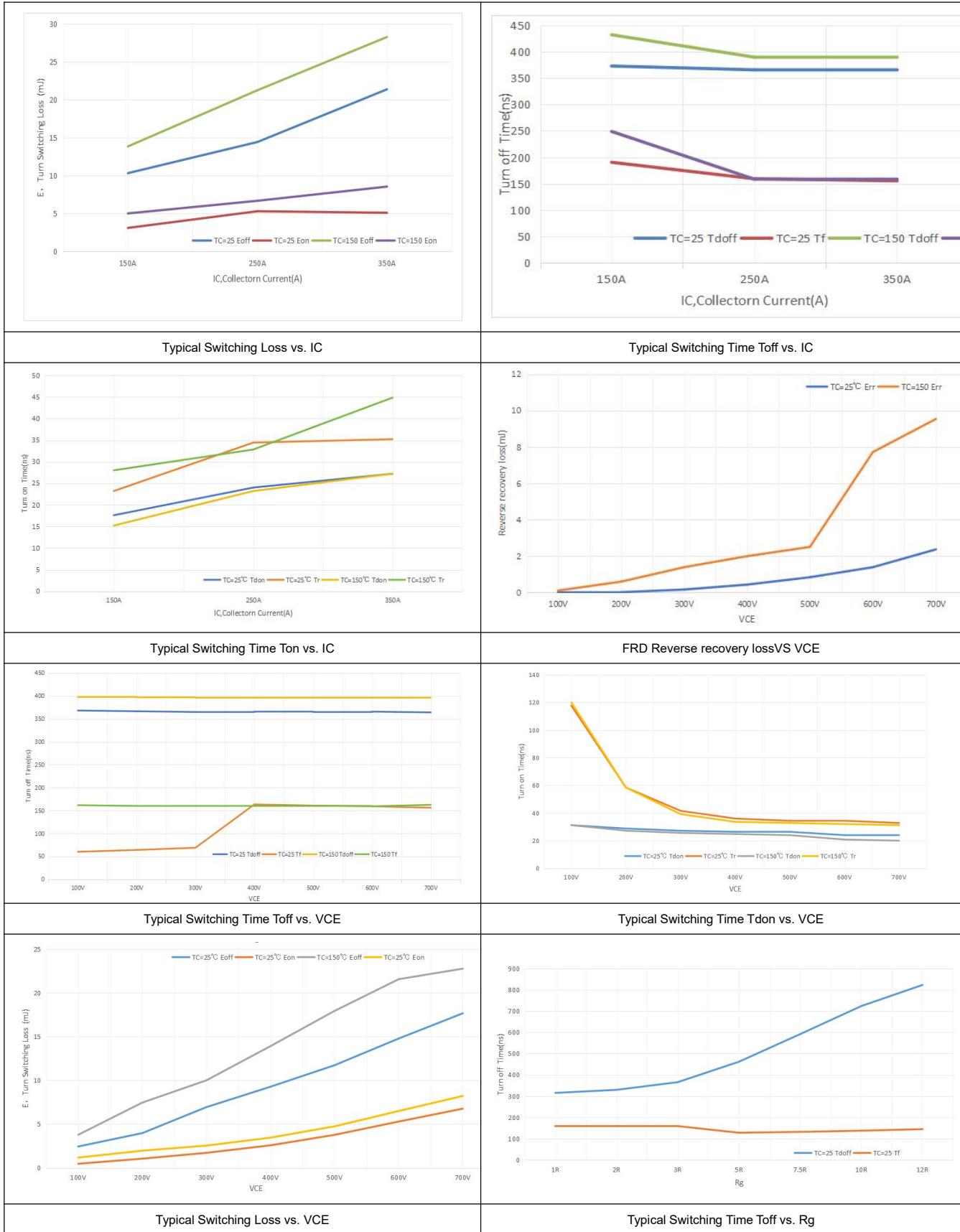
5.5 Electrical Characteristics (IGBT) ($T_c=25^\circ\text{C}$, unless otherwise specified)

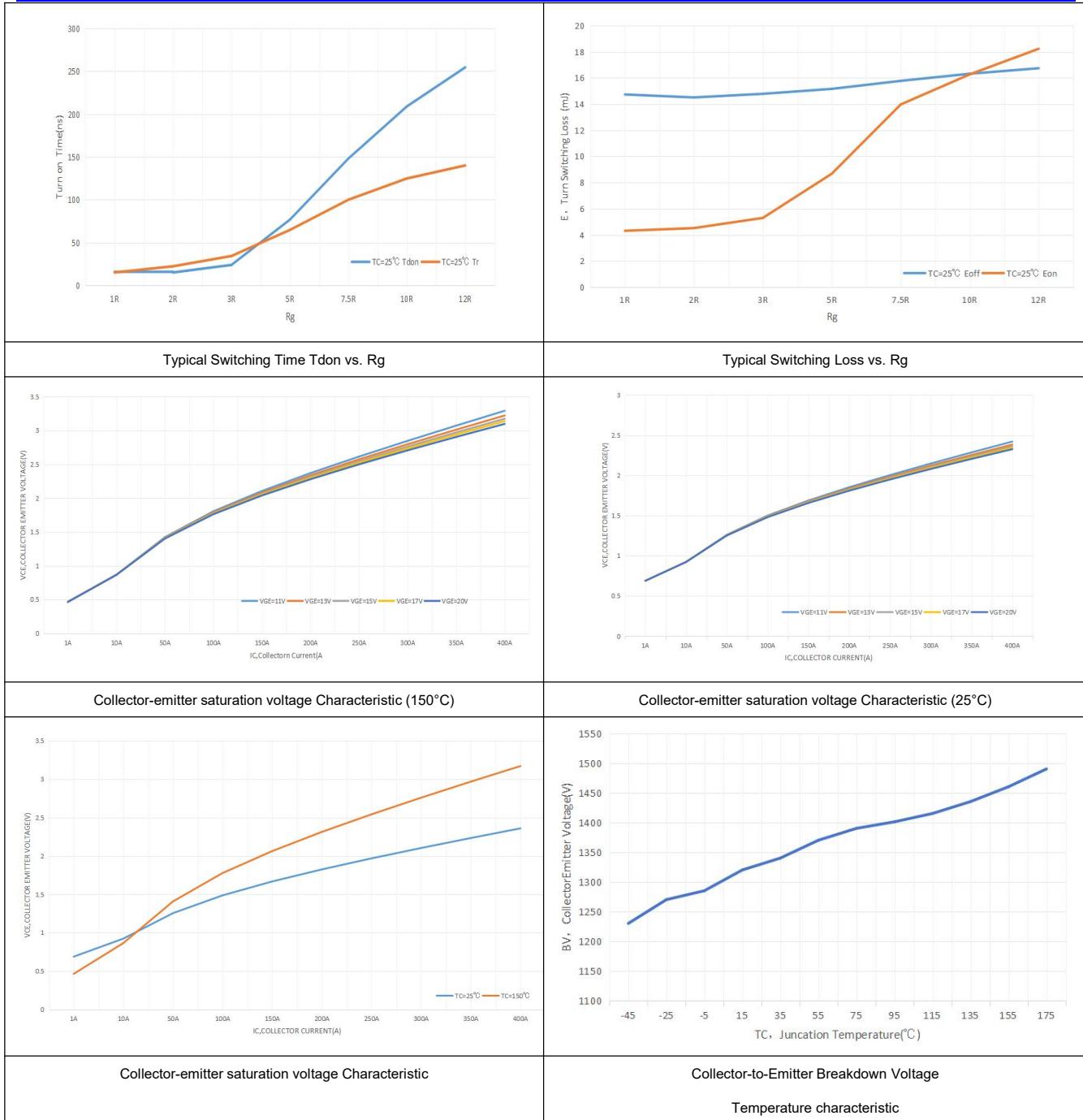
Parameter	Symbol	Conditions	Value			Units
			Min	Typ	Max	
Static Characteristics						
Collector-to-Emitter Breakdown Voltage	$V_{(\text{BR})\text{CES}}$	$I_C=1\text{mA}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$	1200	--	--	V
Collector-to-Emitter Leakage Current	I_{CES}	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$	--	--	100	μA
		$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$	--	--	5.0	mA
Gate-to-Emitter Leakage	I_{GES}	$V_{GE}=\pm 20\text{V}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$	--	--	± 100	nA
Gate Threshold Voltage	$V_{GE(\text{th})}$	$V_{CE}=V_{GE}, I_C=3\text{mA}$	4.5	5.6	6.5	V
Collector-emitter saturation voltage	$V_{CE\text{sat}}$	$V_{GE}=15\text{V}, I_C=150\text{A}, T_j=25^\circ\text{C}$	--	2.55	3.0	V
		$V_{GE}=15\text{V}, I_C=150\text{A}, T_j=150^\circ\text{C}$	--	3.1	--	V
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}, T_a=25^\circ\text{C}$	--	18.7	--	nF
Output Capacitance	C_{oss}		--	0.46	--	
Reverse Transfer Capacitance	C_{rss}		--	0.22	--	
IGBT Characteristics						
Turn-on delay time	$t_{d(on)}$	$V_{CE}=600\text{V}, I_C=150\text{A}, R_g=5.0\Omega, V_{GE}=\pm 15\text{V}, \text{感性负载}, T_j=25^\circ\text{C}$	--	32	--	nS
Rise time	t_r		--	37	--	nS
Turn-off delay time	$t_{d(off)}$		--	188	--	nS
Fall time	t_f		--	116	--	nS
Turn-on energy	E_{on}		--	4.8	--	mJ
Turn-off energy	E_{off}		--	4.6	--	mJ
Total switching energy	E_{ts}		--	9.4	--	mJ
Turn-on delay time	$t_{d(on)}$	$V_{CE}=600\text{V}, I_C=150\text{A}, R_g=5.0\Omega, V_{GE}=\pm 15\text{V}, \text{感性负载}, T_j=150^\circ\text{C}$	--	28.8	--	nS
Rise time	t_r		--	36	--	nS
Turn-off delay time	$t_{d(off)}$		--	208.8	--	nS
Fall time	t_f		--	196	--	nS
Turn-on energy	E_{on}		--	7.1	--	mJ
Turn-off energy	E_{off}		--	7.19	--	mJ
Total switching energy	E_{ts}		--	14.29	--	mJ
Gate charge	Q_g	$V_{CE}=600\text{V}, V_{GE}=-15\text{V to } 15\text{V}$	--	0.7	--	uC

5.6 Electrical Characteristics (Diode) ($T_c=25^\circ\text{C}$, unless otherwise specified)

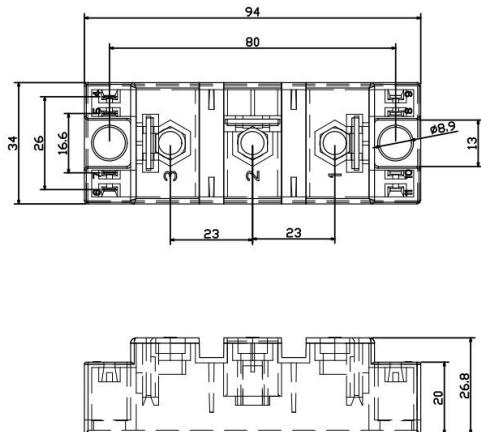
Parameter	Symbol	Conditions	Value			Units
			Min	Typ	Max	
Diode forward voltage	V_F	$I_F=150\text{A}, T_j=25^\circ\text{C}$	--	2.8	--	V
		$I_F=150\text{A}, T_j=150^\circ\text{C}$	--	1.8	--	V
Diode reverse recovery time	t_{rr}	$V_{CE}=600\text{V}, I_C=150\text{A}, R_g=5\Omega, V_{GE}=\pm 15\text{V}$ $TC=25^\circ\text{C}$	--	66	--	ns
Diode peak reverse recovery current	I_{rrm}		--	50	--	A
Diode reverse recovery charge	Q_{rr}		--	2.6	--	uC
Reverse recovery energy	E_{rec}		--	1.55	--	mJ
Diode reverse recovery time	t_{rr}	$V_{CE}=600\text{V}, I_C=150\text{A}, R_g=5\Omega, V_{GE}=\pm 15\text{V}$ $TC=150^\circ\text{C}$	--	315	--	ns
Diode peak reverse recovery current	I_{rrm}		--	95	--	A
Diode reverse recovery charge	Q_{rr}		--	18	--	uC
Reverse recovery energy	E_{rec}		--	7.4	--	mJ

6 Typical Characteristic Curves

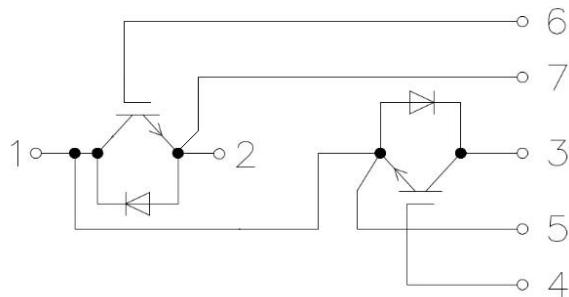




7 Dimensions



7.1 Circuit Schematic



8 Attentions

- Jiangsu Donghai Semiconductor Technology CO.,LTD. reserves the right to change the specification without prior notice! The customer should obtain the latest version of the information before making the order and verify that the information is complete and up to date.
- It is the responsibility of the purchaser for any failure or failure of any semiconductor product under certain conditions. It is the responsibility of the purchaser to comply with safety standards and to take safety measures in the system design and machine manufacturing of Donghai products in order to avoid potential risk of failure. Injury or property damage.
- Product promotion is endless, our company will be dedicated to provide customers with better products.

9 Appendix

Revision history:

Date	REV.	Description	Page
2024.6.25	1.0	Original	